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October 2013

ISL9V3036D3S / ISL9V3036S3S / ISL9V3036P3 EcoSPARK[®] 300mJ, 360V, N-Channel Ignition IGBT

General Description

FAIRCHILD SEMICONDUCTOR

The ISL9V3036D3S, ISL9V3036S3S, and ISL9V3036P3 are the next generation IGBTs that offer outstanding SCIS capability in the space saving D-Pak (TO-252), as well as the industry standard D²-Pak (TO-263) and TO-220 plastic packages. These devices are intended for use in automotive ignition circuits, specifically as a coil drivers. Internal diodes provide voltage clamping without the need for external components.

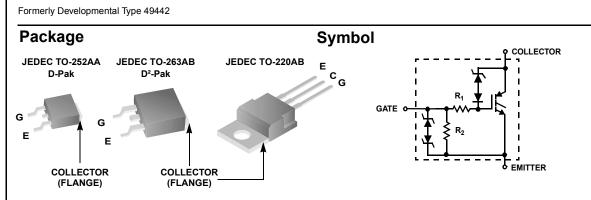
EcoSPARK® devices can be custom made to specific clamp voltages. Contact your nearest Fairchild sales office for more information.

Applications

- Automotive Ignition Coil Driver Circuits
- Coil- On Plug Applications

Features

- Industry Standard D²-Pak package
- SCIS Energy = 300mJ at T_J = 25°C
- Logic Level Gate Drive

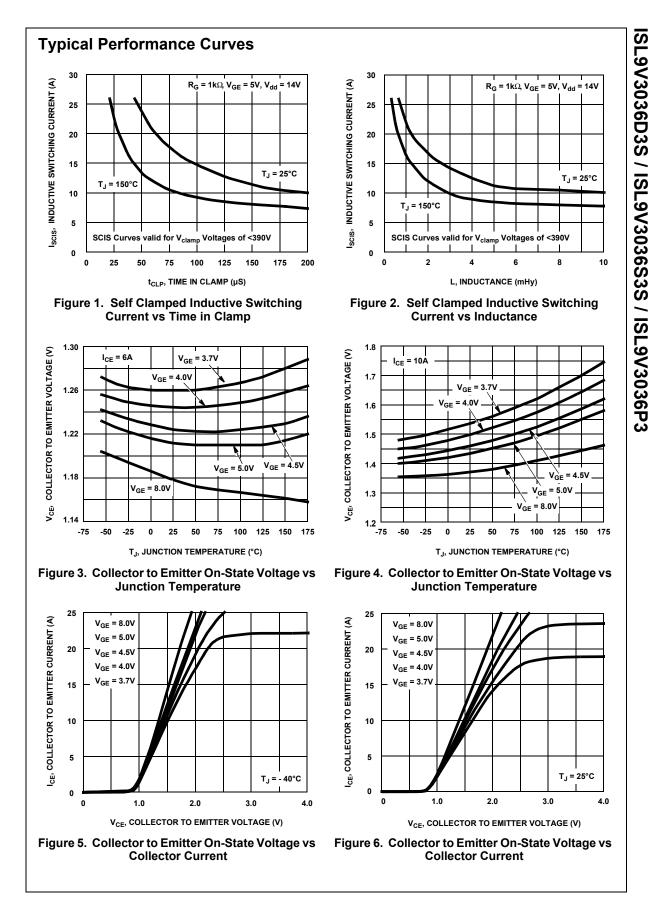


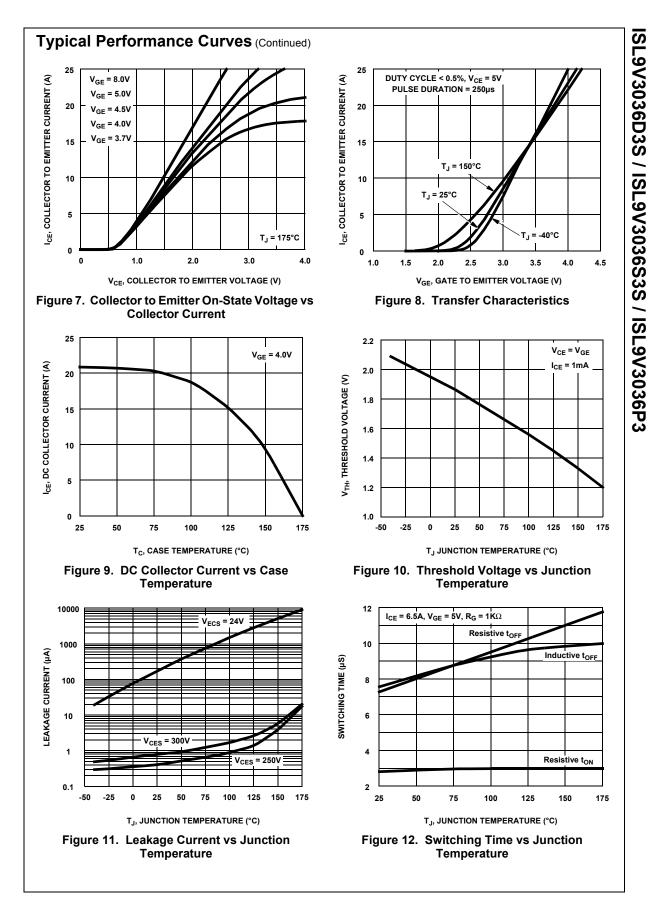
Device Maximum Ratings T_J = 25°C unless otherwise noted

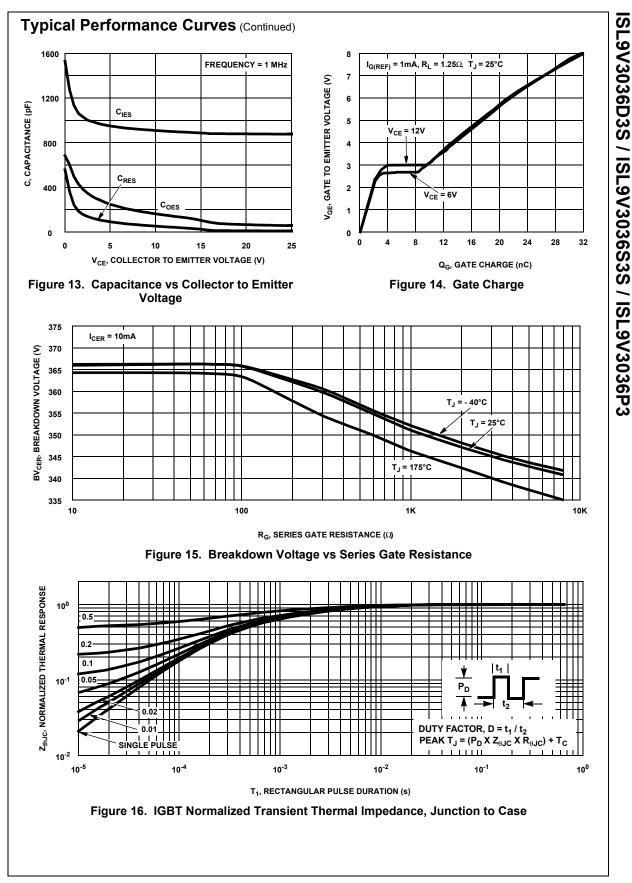
Symbol	Parameter	Ratings	Units	
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1 mA)	360	V	
BV _{ECS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10 mA)	24	V	
E _{SCIS25}	T _J = 25°C, I _{SCIS} = 14.2A, L = 3.0 mHy	300	mJ	
E _{SCIS150}	T _J = 150°C, I _{SCIS} = 10.6A, L = 3.0 mHy	170	mJ	
I _{C25}	Collector Current Continuous, At T _C = 25°C, See Fig 9	21	Α	
I _{C110}	Collector Current Continuous, At T _C = 110°C, See Fig 9	17	Α	
V_{GEM}	Gate to Emitter Voltage Continuous	±10	V	
PD	P_D Power Dissipation Total $T_C = 25^{\circ}C$		W	
	Power Dissipation Derating $T_{C} > 25^{\circ}C$	1.0	W/°C	
ΤJ	Operating Junction Temperature Range	-40 to 175	°C	
T _{STG} Storage Junction Temperature Range		-40 to 175	°C	
T _L Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)		300	°C	
T _{pkg}	Max Lead Temp for Soldering (Package Body for 10s)	260	°C	
ESD	Electrostatic Discharge Voltage at 100pF, 1500 Ω	4	kV	

		king	Device Package		Reel Size		Tape Width		G	Quantity	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$			TO-252AA	330mm		•		İ	2500		
	V3036S ISL9V3036S3ST TO-263,		TO-263AB	330mm		24mm			800		
V3036SISL9V3036S3STO-263ABTubeN/A50Identified to the state of the sta	V3036P		ISL9V3036P3	TO-220AA	Tube		N/A			50	
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	V3036D ISL9V3036D3S TO-252AA		Tube		N/A			75			
							1	N/A		50	
ff State Characteristics BV_{CER} Collector to Emitter Breakdown Voltage $\begin{vmatrix} c = 2mA, V_{GE} = 0, \\ R_G = 1K\Omega, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_J = -40 to 150^{\circ}C \\ R_G = 0, See Fig. 15 \\ T_G = 150^{\circ}C \\ R_G = 100 \\ R$		al C					Min	Тур	Мах	Units	
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$		Char									
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	BV _{CER}				$R_G = 1K\Omega$, See Fig. 15		330	360	390	V	
$\begin{array}{ c c c c c c } \hline T_{C} = 25^{\circ}C & T_{C} = 14^{\circ}A & T_{C} = 15^{\circ}C & T_{C} = 1$	BV _{CES}	Colle	ector to Emitter Brea	$I_{C} = 10$ mA, $V_{GE} = 0$, R _G = 0, See Fig. 15		350	380	410	V		
$ \begin{array}{ c_{\text{CER}} \\ c_{\text{CR}} \\ c_{\text{CR}}$	BV _{ECS}	Emit	ter to Collector Brea	I _C = -75mA, V _{GE} = 0V,		30	-	-	V		
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	BV_{GES}	Gate	e to Emitter Breakdo	wn Voltage			±12	±14	-	V	
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	I _{CER}	Colle	ector to Emitter Lea	kage Current		-	-	-	25	μA	
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$					See Fig. 11	Ŭ	-	-		mA	
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	I _{ECS}	Emitter to Collector Leakage Current					-	-		mA	
R2Gate to Emitter Resistance10K-26KΩn State Characteristics $V_{CE(SAT)}$ Collector to Emitter Saturation Voltage $I_C = 6A$, $V_{GE} = 4V$ $T_C = 25^\circ$ C, See Fig. 3-1.251.60V $V_{CE(SAT)}$ Collector to Emitter Saturation Voltage $I_C = 10A$, $V_{GE} = 4.5V$ $T_C = 150^\circ$ C, 				Fig. 11	T _C = 150°C	-	-	40			
a State Characteristics $V_{CE(SAT)}$ Collector to Emitter Saturation Voltage $I_C = 6A$, $V_{GE} = 4V$ $T_C = 25^{\circ}C$, $See Fig. 3$ -1.251.60V $V_{CE(SAT)}$ Collector to Emitter Saturation Voltage $I_C = 10A$, $V_{GE} = 4.SV$ $T_C = 150^{\circ}C$, $See Fig. 4$ -1.581.80V $V_{CE(SAT)}$ Collector to Emitter Saturation Voltage $I_C = 10A$, $V_{GE} = 4.SV$ $T_C = 150^{\circ}C$, $See Fig. 4$ -1.581.80V $V_{CE(SAT)}$ Collector to Emitter Saturation Voltage $I_C = 10A$, $V_{GE} = 5V$, See Fig. 14-1.70nC $V_{CE(SAT)}$ Gate CharacteristicsIc = 10A, $V_{CE} = 12V$, $V_{GE} = 5V$, See Fig. 14-17-nC $V_{GE(TH)}$ Gate to Emitter Threshold Voltage $I_C = 1.0mA$, $V_{CE} = V_{GE}$ See Fig. 10 $T_C = 25^{\circ}C$ 1.3-2.2V $V_{GE(TH)}$ Gate to Emitter Plateau Voltage $I_C = 1.0mA$, $V_{CE} = V_{GE}$ See Fig. 10 $T_C = 150^{\circ}C$ 0.75-1.8V V_{GEP} Gate to Emitter Plateau Voltage $I_C = 10A$, $V_{CE} = 14V$, $R_L = 10A$, $V_{CE} = 12V$ -3.0-Vwitching Characteristics $t_{q(ON)R}$ Current Turn-On Delay Time-Resistive $T_J = 25^{\circ}C$, See Fig. 12-0.74 μs $t_{q(OFF)L}$ Current Rise Time-Resistive $V_{CE} = 300V$, $R_c = 1K\Omega$ $T_J = 25^{\circ}C$, See Fig. 12-2.815 μs $t_{q(OFF)L}$ Current Fall Time-Inductive<		_				-	70	-			
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		-		uration Voltage			-	1.25	1.60	V	
$\begin{array}{ c c c c c c } \hline V_{CE}(SAT) & V_{CE}(SAT) & Collector to Emitter Saturation Voltage & I_{C} = 15A, \\ V_{CE}(SAT) & Collector to Emitter Saturation Voltage & I_{C} = 15A, \\ V_{GE} = 4.5V & T_{C} = 150^{\circ}C & - & 1.90 & 2.20 & V \\ \hline \end{array}$	V _{CE(SAT)}	Colle	ector to Emitter Satu	ration Voltage	0	-	-	1.58	1.80	V	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $					V _{GE} = 4.5V	See Fig. 4				V	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	VCE(SAT)	Colle		ination voltage	-	1 _C = 150 C	-	1.90	2.20	v	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	ynamic	Char	acteristics								
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Q _{G(ON)}	Gate	Sate Charge		I _C = 10A, V _{CE} = V _{GE} = 5V, See	: 12V, Fig. 14	-	17	-	nC	
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	V _{GE(TH)}	Gate	e to Emitter Thresho	ld Voltage		-	1.3	-	2.2		
Volspacewitching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.74 μs t_{rR} Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -2.17 μs t_{rR} Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, R_L = 500\mu H,$ -4.815 μs t_{fL} Current Fall Time-Inductive $V_{CE} = 5V, R_G = 1K\Omega$ -2.815 μs $T_J = 25^{\circ}C, See Fig. 12$ T25^{\circ}C, See Fig. 12-300mJSCISSelf Clamped Inductive Switching $T_J = 25^{\circ}C, L = 3.0 \text{ mH},$ $R_G = 1K\Omega, V_{GE} = 5V$ 300mJ						T _C = 150°C	0.75	-	1.8	V	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	V_{GEP}	Gate	e to Emitter Plateau	Voltage	I _C = 10A,	V _{CE} = 12V	-	3.0	-	V	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	witching									1	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	t _{d(ON)R}						-	-		μs	
$ \begin{array}{c c} \hline t_{fL} & Current Fall Time-Inductive & V_{GE}^{c} = 5V, R_{G} = 1K\Omega & - & 2.8 & 15 & \mu s \\ \hline T_{J} = 25^{\circ}C, See Fig. 12 & - & 300 & mJ \\ \hline SCIS & Self Clamped Inductive Switching & T_{J} = 25^{\circ}C, L = 3.0 & mH, \\ R_{G} = 1K\Omega, V_{GE} = 5V & - & 300 & mJ \\ \hline \end{array} $				T _J = 25°C, See Fig. 12		-			μs		
TLTJ = 25°C, See Fig. 12SCISSelf Clamped Inductive Switching $T_J = 25°C, L = 3.0 \text{ mH}, -$ $R_G = 1K\Omega, V_{GE} = 5V$ -300mJ	t _{d(OFF)L}		•				-	_	_	· ·	
$R_{G} = 1K\Omega, V_{GE} = 5V$					T _J = 25°C, See Fig. 12		-				
nermal Characteristics	SCIS						-	-	300	mJ	
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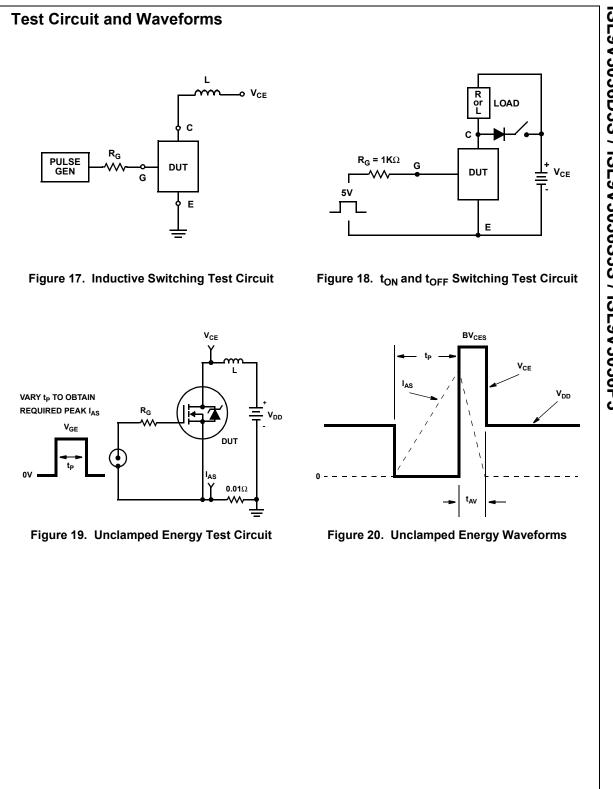
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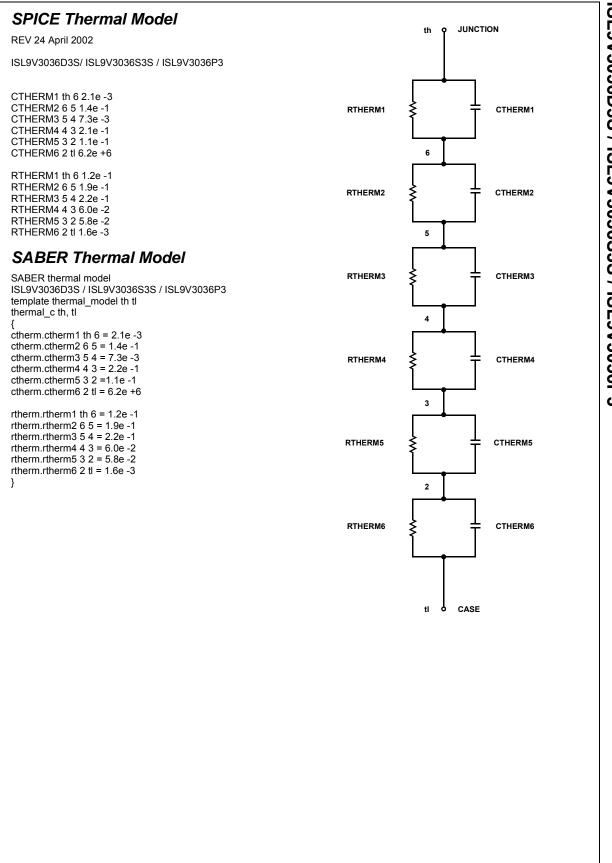




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